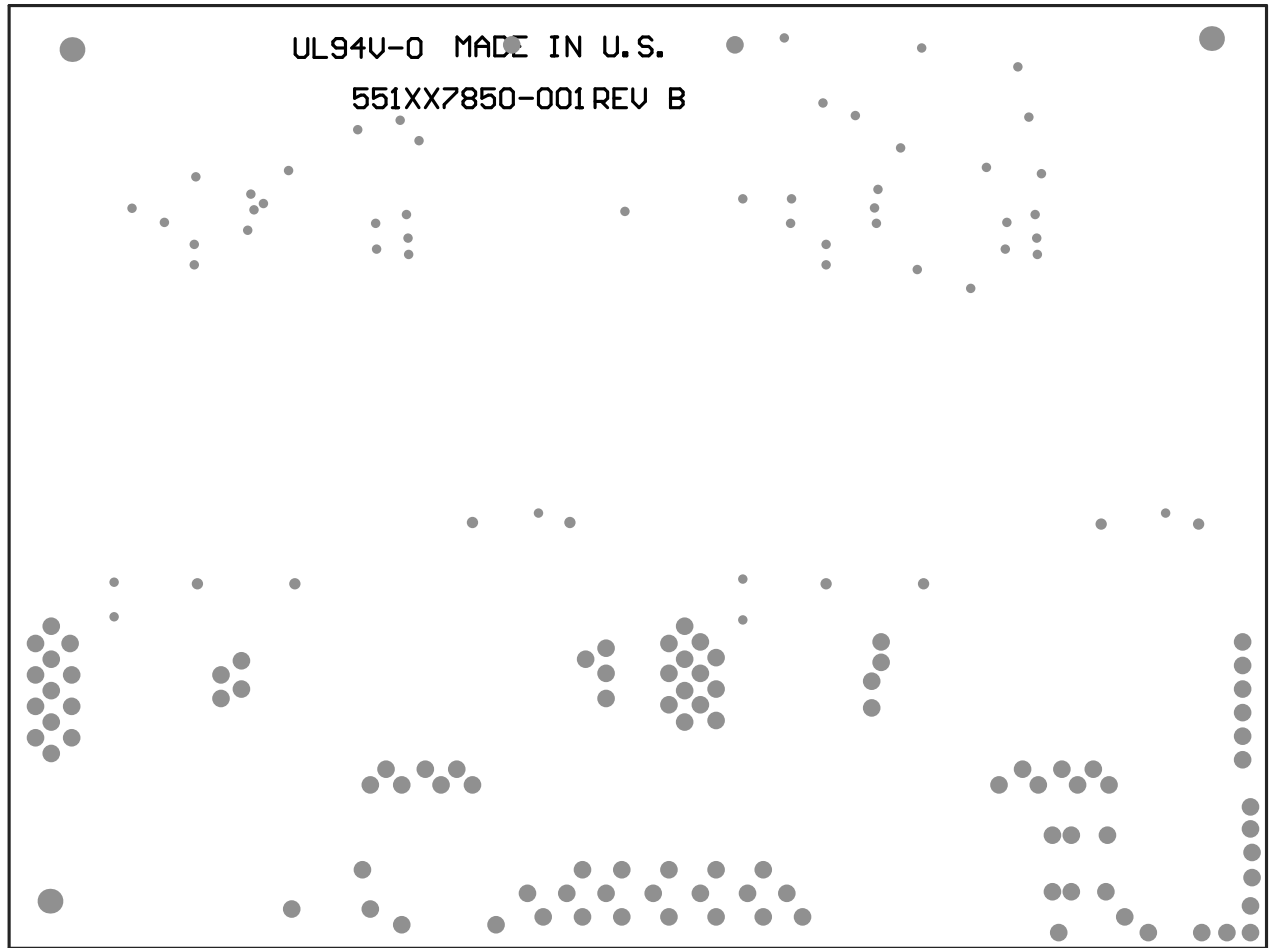


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS  
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	PROJECT NAME = PMP7850 REV B	
LAYER NAME = Top Overlay	ARTWORK # = 880XX7850-001 REV B	TEXAS INSTRUMENTS
PLOT NAME = Top Assembly Drawing	GENERATED : 4/10/2015	5:40:18 PM



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED, AND MAY NOT BE IN BILL OF MATERIALS  
ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	PROJECT NAME = PMP7850 REV B		
LAYER NAME =	ARTWORK #88 = 880XX7850-001 REV B	DESIGNED BY	TEXAS INSTRUMENTS
PLOT NAME = Bottom Assembly Drawing	GENERATED	: 4/10/2015	5:40:19 PM

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